

## **Spec Sheet** Version:1.3

# **CWDM Analog Bi-Directional Optical Subassembly**

### Description

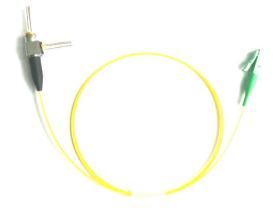
LBxx12 series has a CWDM(TX)/1550nm(RX) Bi-direction Optical Subassembly (BOSA) for analog transmission application .

This module contains a O&E band(1260~1460nm) MQW CWDM laser diode as transmitter, the wavelength of CWDM will be selected, an InGaAs/ InP PIN as receiver, an edge filter (CWDM transmit / 1550nm reflect) to separate orginal band and 1550nm laser.

The TX with an InGaAs monitor PD, it can be used with appropriate feedback control circuitry to set optimal power level for each CWDM DFB laser, As the current changed above the threshold, the optical power will change accordingly.

The PIN transduces incident light into optical current with high efficiency. The PIN chip has a photosensitivity area diameter of 80um with a InGaAs planar structure.

The products has single mode type fiber(G.657A) with a FC/APC or SC/APC optical connector can be selected.



#### Features

- Transmitter with uncooled CWDM-DFB-LD (1260~1460nm)
- Transmitter with isolator
- Low noise, low distortion, Low threshold current
- 1550nm PIN diode receiver
- Low optical crosstalk
- operating temperature range: 0°C to 70°C
- Fiber is meet the G.657A standard

### Application

- RFOG system application
- Suitable for CATV/CDMA application



### Absolute Maximum Ratings<sup>[1]</sup>

Parameter	Symbol	Min	Max	Units	Notes
Reverse Voltage(LD)	V <sub>RL</sub>		2	V	
Forward Current(LD)	IFL		120	mA	
Reverse Voltage(MPD)	VRMP		15	V	
Forward Current(MPD)	IFMP		2	mA	
Reverse Voltage(PIN)	VRP		20	V	
Forward Current(PIN)	IR		5	mA	
Fiber Input Power	Pin		10	dBm	
Operating Temperature <sup>[1]</sup>	T <sub>c</sub>	-10	+85	°C	Case temperature
Storage Temperature	T <sub>STG</sub>	-40	+85	°C	Ambient temperature
Relative Humidity	RH		80	%	
Lead Soldering Temperature/Time	Τ <sub>s</sub>		260/10	°C/S	
Fiber bend radius		10		mm	
Fiber yield strength			1	kgf	

**Note 1:** Beyond the scope of absolute maximum ratings can cause permanent damage to the device. If it has been a long time to use the device in the absolute maximum ratings may affect device reliability.

### **Electric and Optical Characteristics**

(All measurements are at Case temperature of 25  $^\circ$ C ±3  $^\circ$ C , @1310±10nm unless stated otherwise.)

Transmitter Operating Characteristic-Optical, Electrical							
Parameter	Symbol	Min	Typical	Max	Units	Notes	
Fiber Output Power	Ро	1.0	1.4		mW	CW, If=Ith+20mA	
Slope Efficiency	η	0.05	0.07		W/A	CW	
Center Wavelength	λ	Code List		nm	CW, If=Ith+20mA		
Spectral Width(-20dB)	Δλ		0.2	1	nm	CW, If=Ith+20mA	
Side-Mode Suppression Ratio	SMSR	30			dB	CW,If=Ith+20mA	
Tracking Error	TE <sup>[1]</sup>	-1.5		1.5	dB	I <sub>M</sub> hold@P <sub>0</sub> =1.5mW,25°C CW,Tc= 0 ~+70°C	
Threshold Current	I <sub>th</sub>		8	15	mA	CW	
			30	45	mA	<b>СW, Tc= +70</b> °С	
Operating Voltage	V <sub>F</sub>		1.2	1.7	V	CW,If=Ith+20mA	
Monitor Current	Ι <sub>Μ</sub>	100		1300	μA	CW, If=Ith+20mA,V <sub>RMP</sub> =1V	
Monitor Dark Current	I <sub>D</sub>			200	nA	CW,V <sub>RMP</sub> =5V	
Photodiode Capacitance	С			10	pF	V <sub>RMP</sub> =5V,f=1MHz	
Rise time	Tr			150	Ps	Unfilter 20%~80%	
Fall time	Tf			150	Ps	Unfilter 20%~80%	
Relative Intensity Noise	RIN		-145		dB/Hz	CW, If=Ith+20mA	

Wuhan LinkPhotonic Technology Inc.

www.linkphotonic.com



### LBxx12 series BOSA Module

WS

Receiver Operating Characteristic-Optical, Electrical							
Parameter	Symbol	Min	Typical	Max	Units	Notes	
Operating Wavelength	λ	1545	1550	1565	nm		
Saturation Power	Psat	3			dBm		
Responsivity	R	0.8	0.9		A/W	VRP=5V, λ=1550nm	
Supply Voltage	Vs		-12	-5	v		
Active Area	Φ		75		μm		
Small Signal Bandwidth	BW	3.0			GHz	-3dB, VRP=12V	
Dark Current	I <sub>D</sub>			1	nA	VRP = 5 V	
Composite Second Order beat	CSO <sup>[2]</sup>			-70	dBc	λ=1550nm	
Composite Third Order beat	CTB <sup>[2]</sup>			-80	dBc	λ=1550nm	
Capacitance	С			0.8	PF	VRP=5V,f=1MHz	
Other Characteristic-Optic	al, Electri	cal					
Parameter	Symbol	Min	Typical	Max	Unit	Notes	
Optical Crosstalk	CRT			-40	dB		
Return Loss	RL	40			dB	$\lambda$ =1310nm, with isolator	
		40			dB	λ=1550nm	
Optical Isolation	lso	30			dB	$\lambda$ =1260nm $\sim$ 1510nm	
		15				$\lambda$ =1510nm $\sim$ 1537nm	
		15				$\lambda$ =1583nm $\sim$ 1595nm	
		30				$\lambda$ =1597nm $\sim$ 1650nm	
Exterior fiber diameter		0.8	0.9	1.0	mm	70°C max temperature	

Notes1:TE=10\*log(Pf(Tc)/Pf(25°C)) @ APC with monitor current is constant.

L

ORL

Notes2:Two-tone test condition : f1=50MHz, f2=505MHz, f1±f2, VRP=-12V,Pavg=0dBm,MI=0.4,Rload=75Ω.

1000

----

1100

---

mm

dB

900

45

### **Pigtail parameters**

**Optical Connector Return loss** 

Pigtail Length

Parameter	Symbol					
Optical connector	LC/APC (IEC874/7)					
Mode field diameter	9.5±1um					
Cladding diameter	125±2um					
Outermost Jacket	900±100um					
Jacket color	Yellow or White					
Pigtail Length	0.63±0.03m					

Wuhan LinkPhotonic Technology Inc.

www.linkphotonic.com sales@linkph

Outline Dimensions[L]

APC connector

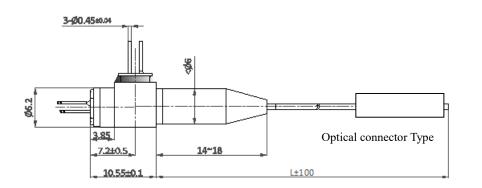


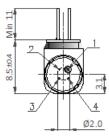
LBxx12 series BOSA Module

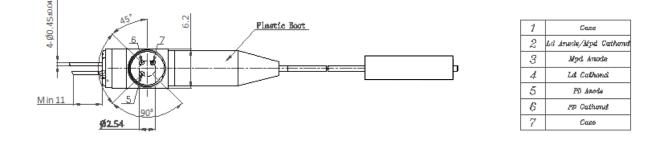
WS

### **Outline Dimensions**

All dimensions are ±0.1mm unless otherwise specified (Unit: mm). For detail information please contact LinkPhotonic.







#### Precautions

Semiconductor chips are sensitive to electro-static damage. The module shall be packed with antistatic material for transportation. The working station and operators shall be grounded. Switching transients can cause electrical overstress (EOS) damage to the chips. EOS be may resulted from improper ESD handling, improper power sequencing, a faulty power supply or an intermittent connection.

a. Operators should always use antistatic bands and clothing, electric conductive shoes, and other safety appliances while at work are highly recommended.

b. Humidity in working environment should be controlled equal or above 40 percent RH.

c. It is recommended that grounding mats be placed on the surfaces of assembly line workbench and the surrounding floor in working area, etc.

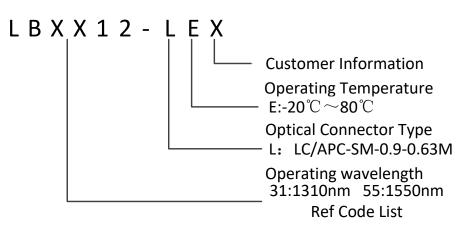
d. When mounting this product in other parts or materials which can be electrically charged (printed wiring boards, plastic products, etc.), pay close attention to the static electricity in those parts. ESD may damage the product.



LBxx12 series BOSA Module

WS

Ordering Information



### Wavelength

The wavelength of CWDM DFB LD as Code List at 25±3°C.

хх	Center of wavelenth	Δλ	хх	Center of wavelenth	Δλ
27	1270nm	±3nm	45	1450nm	±3nm
29	1290nm	±3nm	47	1470nm	±3nm
31	1310nm	±3nm	49	1490nm	±3nm
33	1330nm	±3nm	51	1510nm	±3nm
35	1350nm	±3nm	53	1530nm	±3nm
37	1370nm	±3nm	55	1550nm	±3nm
39	1390nm	±3nm	57	1570nm	±3nm
41	1410nm	±3nm	59	1590nm	±3nm
43	1430nm	±3nm	61	1610nm	±3nm

#### Statement

The information provided herein is believed to be reliable, LinkPhotonic assumes no liability for inaccuracies or omissions. LinkPhotonic assumes no responsibility for the use of this information, and all such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. LinkPhotonic does not authorize or warranty any LinkPhotonic product for use in life-support devices and/or systems. Copyright © 2014 LinkPhotonic Inc. All rights reserved.